

1 **DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION**

2 As the below named inventor, I hereby declare that:

3 My residence, post office address and citizenship are as stated
4 below next to my name.

5 I believe I am the original, first and sole inventor of the subject
6 matter which is claimed and for which a patent is sought on the
7 invention entitled: Microelectronic Device Fabricating Method, Integrated
8 Circuit, and Intermediate Construction, the specification of which is
9 attached hereto.

10 I hereby state that I have reviewed and understand the contents
11 of the above-identified specification, including the claims.

12 I acknowledge the duty to disclose information known to me to be
13 material to patentability as defined in Title 37, Code of Federal
14 Regulations §1.56.

15 **PRIOR FOREIGN APPLICATIONS:**

16 I hereby state that no applications for foreign patents or inventor's
17 certificates have been filed prior to the date of execution of this
18 declaration.

19 I hereby declare that all statements made herein of my own
20 knowledge are true and that all statements made on information and
21 belief are believed to be true; and further that these statements were
22 made with the knowledge that willful false statements and the like so

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1 made are punishable by fine or imprisonment, or both, under
2 Section 1001 of Title 18 of the United States Code and that such willful
3 false statement may jeopardize the validity of the application or any
4 patent issued therefrom.

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6 Full name of sole inventor: Alan R. Reinberg

7 Inventor's Signature: Alan R. Reinberg

8 Date: Nov. 16, 1999

9 Residence: Westport, CT

10 Citizenship: U.S.A.

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THE UNITED STATES GOVERNMENT